

BYV21MX-650P Ultrafast power diode

Rev.01 - 23 December 2022

Product data sheet

1. General description

Ultrafast power diode in a TO220F-2L plastic package.

2. Features and benefits

- Fast switching
- Isolated plastic package
- Low leakage current
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses in associated MOSFET or IGBT

3. Applications

- Active PFC in air conditioner
- High frequency switched-mode power supplies
- Power Factor Correction (PFC)

4. Quick reference data

Table 1.	Quick	reference	data

Symbol	Parameter	Conditions	Notes		Values		Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			650		V	
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; <u>Fig. 1; Fig. 2; Fig. 3</u>		20			A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; $t_{\rm p}$ = 25 µs; square-wave pulse		40			A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4		180			A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse			198		А
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 20 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.90	2.60	V
		I _F = 20 A; T _j = 150 °C; <u>Fig. 6</u>		-	1.50	2.20	V
Dynamic	characteristics	·					
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig. 7</u>		-	26	-	ns

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	А	anode	000	к – Ң – А
mb	n.c.	mounting base; isolated		001aaa020

6. Ordering information

Table 3. Ordering information							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
BYV21MX-650P	TO220F-2L	BYV21MX-650PQ	Tube	50	TO220Fd-2L	02-Aug-2022	

7. Marking

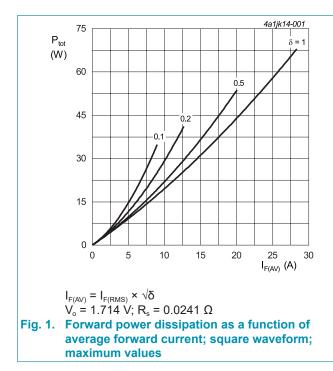
Table 4. Marking codes	
Type number	Marking codes
BYV21MX-650P	BYV21MX 650P

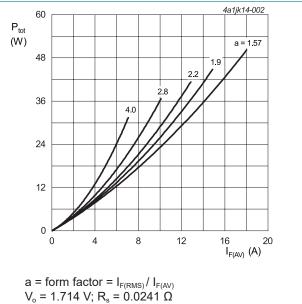
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V _{RRM}	repetitive peak reverse voltage			650	V
V _{RWM}	crest working reverse voltage			650	V
V _R	reverse voltage	DC		650	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; <u>Fig. 1; Fig. 2; Fig. 3</u>		20	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; $t_{\rm p}$ = 25 $\mu s;$ square-wave pulse		40	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4		180	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		198	А
T _{stg}	storage temperature			-65 to 175	°C
Tj	junction temperature			-65 to 175	°C

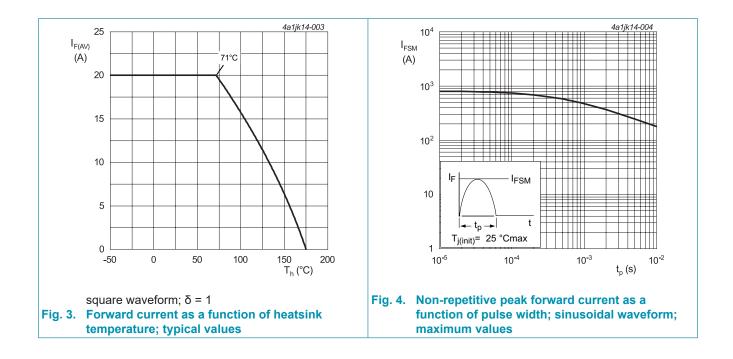




V_o = 1.714 V; R_s = 0.0241 Ω
 Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

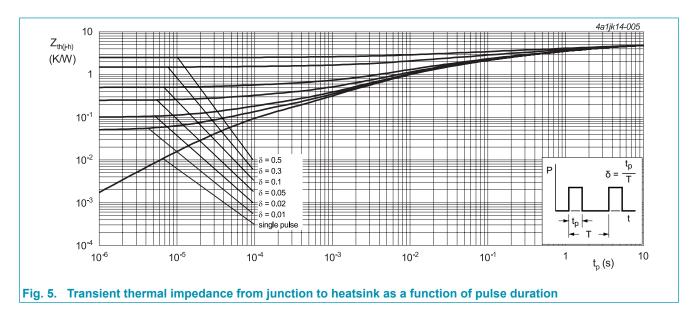
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9. Thermal characteristics

Symbol	ermal characteristics Parameter	Conditions	Notes	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	with heatsink compound; Fig. 5		-	-	4.8	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W

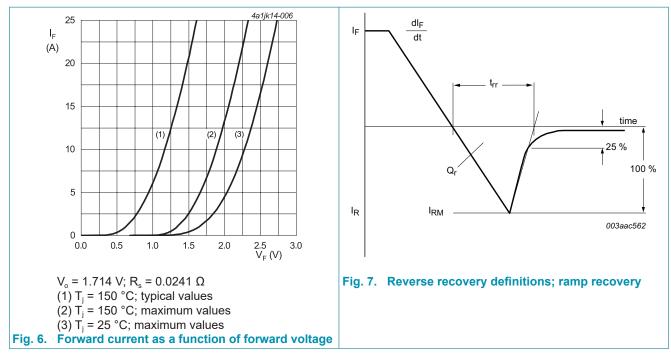


10. Isolation characteristics

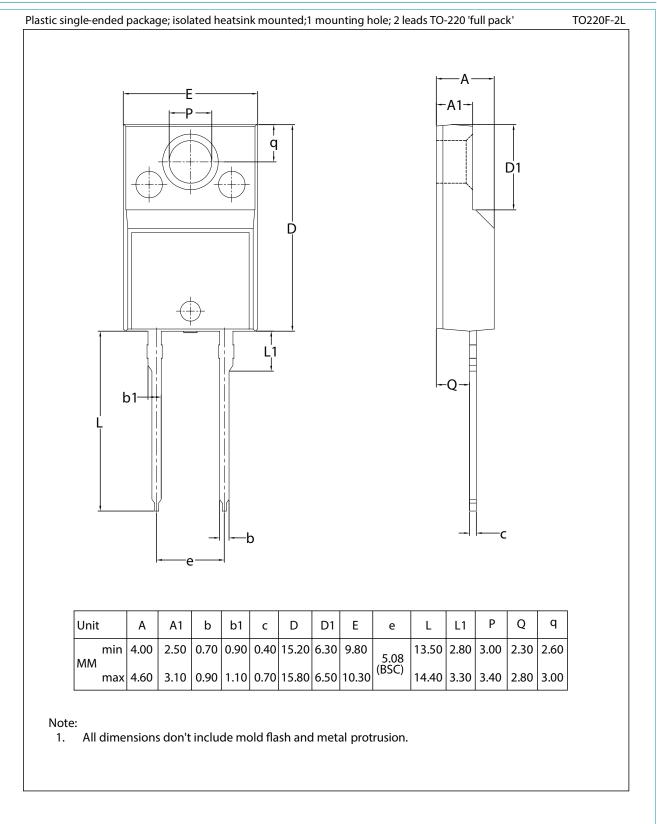
Table 7. Isolation characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	50 Hz \leq f \leq 60 Hz; RH \leq 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free		-	-	2500	V
C_{isol}	isolation capacitance	f = 1 MHz; from cathode to external heatsink		-	10	-	pF

11. Characteristics

Table 8. Cl	haracteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 20 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.90	2.60	V
	I _F = 20 A; T _j = 150 °C; <u>Fig. 6</u>		-	1.50	2.20	V	
I _R	reverse current	V _R = 650 V; T _j = 25 °C		-	0.5	30	μA
		V _R = 650 V; T _j = 150 °C		-	-	0.8	mA
Dynamic	characteristics						
Q _r reverse charge	$I_F = 20 \text{ A}; V_R = 200 \text{ V}; \text{ d}_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	85	-	nC	
	I _F = 20 A; V _R = 200 V; dI _F /dt = 200 A/μs; T _j = 125 °C; <u>Fig. 7</u>		-	350	-	nC	
t _{rr} reverse recovery tin	reverse recovery time	I _F = 0.5 A; I _{rr} = 0.25 A; I _R = 1 A; T _j = 25 °C; <u>Fig. 7</u>		-	28	-	ns
		I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig.</u>		-	26	-	ns
		$I_F = 20 \text{ A}; V_R = 200 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	50	-	ns
		$I_F = 20 \text{ A}; V_R = 200 \text{ V}; \text{ d}_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$		-	90	-	ns
I _{RM}	peak reverse recovery current	$I_F = 20 \text{ A}; V_R = 200 \text{ V}; \text{ d}_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	3.6	-	A
		$I_F = 20 \text{ A}; V_R = 200 \text{ V}; \text{ d}_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$		-	7.5	-	A
E _{as}	non-repetitive avalanche energy	T _{j(init)} = 25 °C		16.8	-	-	mJ



12. Package outline



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13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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